



Attorney Docket No. 15162/06020

DRW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re

U.S. Application of:

Kyu TAKADA, Yuichiro ORI, and Junji
HASHIMURA

For:

OPTICAL PICKUP APPARATUS

Confirmation No.:

7398

U.S. Serial No.:

10/624,285

Filed:

July 22, 2003

Group Art Unit:

2655

Examiner:

To Be Assigned

MAIL STOP AMENDMENT

Commissioner for Patents

P. O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: MAIL STOP AMENDMENT, Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on

June 17, 2005
Date of Deposit

Douglas A. Sorensen
Name of Applicant, Assignee, or Registered
Representative


Signature

June 17, 2005
Date of Signature

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. §1.97(e)

In compliance with the duty of disclosure set forth in 37 C.F.R. § 1.56 and § 1.97(e), Applicants wish to bring the following items to the attention of the Examiner. A copy of each item is enclosed for the convenience of the Examiner.

No representation is made, and no representation is intended, that more relevant material does not exist, or that the order of presentation of this material in any way reflects its relative pertinence. Specifically, this presentation is not an admission that the items listed below are properly citable against the above-identified application.

06/20/2005 SFELEKE1 00000090 181260 10624285

01 FC:1806

180.00 DA

Serial No.: 10/624,285

Submitted herewith:

- (1) "Japanese" Search Report and "Japanese" Written Opinion, having a mailing date of August 24, 2004, concerning international application number PCT/US2004/005866, along with English translations thereof;
- (2) Japanese Patent Application Laid-Open No. (A) 2001-209966, (PIONEER ELECTRONIC CORP.), published August 3, 2001; Together with a copy of an English-language abstract thereof;
- (3) Japanese Patent Application Laid-Open No. (A) 2003-207714, (SAMSUNG ELECTRONICS CO., LTD.), published July 25, 2003; Together with a copy of an English-language abstract thereof;
- (4) Japanese Patent Application Laid-Open No. (A) 2003-067972, (NEC CORP), published March 7, 2003 (was previously presented in the Information Disclosure Statement filed on July 22, 2003), no copy enclosed;
- (5) Katayama, U.S. Patent Application Publication No. US 2002/0181366 A1, published December 5, 2002;
- (6) Kim et al., U.S. Patent Application Publication No. 2003/0095334 A1, published May 22, 2003 (was previously presented by Applicants in the Information Disclosure Statement filed with the continuation-in-part-application, co-pending U.S. patent application Serial No. 10/942,460 on September 16, 2004), no copy enclosed; and
- (7) Kim et al., U.S. Patent Application Publication No. 2003/0107979 A1, published June 12, 2003 (was previously cited by Applicants in the Information Disclosure Statement filed with the continuation-in-part-application, co-pending U.S. patent application Serial No. 10/942,460 on September 16, 2004), no copy enclosed.

Serial No.: 10/624,285

Document (5) is a US counterpart to document (4).

Document (6) is a US counterpart to document (3).

The Japanese Patent Application Laid-Open Nos. (A) 2001-209966 reference (2), and (A) 2003-207714 reference (3) above, are cited in the item (1), "International Search Report and Written Opinion", which indicate the degree of relevances found by the foreign office.

In accordance with 37 CFR § 1.97(e), it is hereby certified that each item of information contained in this Supplemental Information Disclosure Statement is being first cited in a foreign communication in a counterpart foreign application. As this Supplemental Information Disclosure Statement is being filed after the three months from the mailing of the International Search Report and Written Opinion, the required fee of \$180.00 under 37 C.F.R. § 1.97(c)(2) for the submission of the Supplemental Information Disclosure Statement should be charged to Sidley Austin Brown & Wood LLP's Deposit Account No. 18-1260. Please credit any overpayment to Deposit Account No. 18-1260. The Supplemental Information Disclosure Statement (three pages) is being filed in duplicate.

Respectfully submitted,

By: _____


Douglas A. Sorensen
Registration No. 31,570
Attorney for Applicants

DAS/rb
SIDLEY AUSTIN BROWN & WOOD LLP
717 North Harwood
Suite 3400
Dallas, Texas 75201
(214) 981-3482 Direct
(214) 981-3300 Main
(214) 981-3400 Facsimile
June 17, 2005



Substitute for Form 1449A/PTO PATENT & TRADEMARK OFFICE				Complete if Known			
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANTS				Application Number	10/624,285		
Sheet	1	of	1	Confirmation No.	7398		
				Filing Date	July 22, 2003		
				First Inventor	Kyu TAKADA et al.		
				Group Art Unit	2655		
				Examiner Name	To Be Assigned		
				Attorney Docket No.	15162/06020		

U.S. PATENT DOCUMENTS

Examiner Initials	Cite #	DOCUMENT NUMBER	C O D E	PATENTEE	ISSUE DATE (mm/dd/yy)	CLASS	SUB CLASS	Filing Date if Appropriate
	(5)	US 2002/0181366	A1	Katayama	Published 12/05/2002	369	53.2	

FOREIGN PATENT DOCUMENTS

Examiner Initials	O F F I C E	NUMBER	C O D E	PUBLICATION DATE (mm/dd/yy)	TRANSLATION Yes No
	(2)	JP 2001-209966	A	08/03/2001	ABSTRACT ONLY
	(3)	JP 2003-207714	A	07/25/2003	ABSTRACT ONLY

NON PATENT LITERATURE DOCUMENTS

Examiner Initials	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published			
	(1) "Japanese" Search Report and "Japanese" Written Opinion, having a mailing date of August 24, 2004, concerning international application number PCT/US2004/005866, along with English translations thereof			
Examiner Signature				

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with the next communication to applicant.